

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

*In re* Application of: Rajiv Yadav Ranjan : Confirmation No.: 2760  
Serial No.: 10/776,203 : Art Unit: 1795  
Filed: 2/12/2004 : Examiner: Rodney Glenn  
McDonald  
For: METHOD & :  
APPARATUS FOR  
MULTI-STAGE SPUTTER  
DEPOSITION OF  
UNIFORM THICKNESS  
LAYERS

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**SUPPLEMENTAL AMENDMENT ACCOMPANYING ISSUE FEE PAYMENT**

Sir:

In response to the Notice of Allowance mailed July 8, 2010 for the above captioned patent application, Applicants respectfully request entry of the following amendments.